



DFLS140LQ

1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER PowerDI[®]123

Product Summary

V _R (V)	I _F (A)	V _{F MAX} (V) @ +25°C	I _{R MAX} (mA) @ +25°C
40	1.0	0.55	0.1

Features and Benefits

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- High Current Capability and Low Forward Voltage Drop
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (See Note 4)

Description and Applications

This Schottky Barrier Rectifier is designed to meet the stringent requirements of automotive applications. It is ideally suited to use as:

Polarity Protection Diode

- **Re-Circulating Diode**
- Switching Diode

Mechanical Data

- Case: PowerDI[®]123
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 3
- Weight: 0.096 grams (Approximate)

PowerDI[®]123



Top View

Ordering Information (Note 5)

	Part Number	Compliance	Case	Packaging			
	DFLS140LQ-7	Automotive	PowerDI [®] 123	3,000/Tape & Reel			
Notes:	Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.						

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

PowerDI[®]123

	I	F06	ΥM	
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F06 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014)

M = Month (ex: 9 = September)

Date	Code	Key
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Year	2014	20	15	2016	2017	20	18	2019	2020	20	21	2022
Code	В	(2	D	E		F	G	Н			J
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	V
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Forward Current @ T _T = +120°C	I _{F(AV)}	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	50	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	1.67	W
Power Dissipation (Note 7)	PD	556	mW
Thermal Resistance Junction to Soldering Point (Note 8)	R _{eJS}	10	°C/W
Thermal Resistance Junction to Ambient (Note 6)	R _{0JA}	60	°C/W
Thermal Resistance Junction to Ambient (Note 7)	R _{0JA}	180	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 9)	V _{(BR)R}	40			V	I _R = 500μA
				0.36		$I_F = 0.1A, T_J = +25^{\circ}C$
			_	0.30		$I_F = 0.1A, T_J = +85^{\circ}C$
Forward Voltage	VF		—	0.55	V	$I_F = 1.0A, T_J = +25^{\circ}C$
Forward voltage	VF	—	—	0.515		I _F = 1.0A, T _J = +85°C
		_	_	0.85		I _F = 3.0A, T _J = +25°C
		_		0.88		I _F = 3.0A, T _J = +85°C
				0.1		$V_R = 40V, T_J = +25^{\circ}C$
Leakage Current (Note 9)	l-		_	10	mA	V _R = 40V, T _J = +85°C
Leakage Current (Note 9)	I _R		_	0.05	IIIA	V _R = 20V, T _J = +25°C
		_	_	5		V _R = 20V, T _J = +85°C
Total Capacitance	CT		90	_	pF	V _R = 10V, f = 1.0MHz

Notes: 6. Part mounted on 50.8mm X 50.8mm GETEK board with 25.4mm X 25.4mm copper pad, 25% anode, 75% cathode. T_A = +25°C.

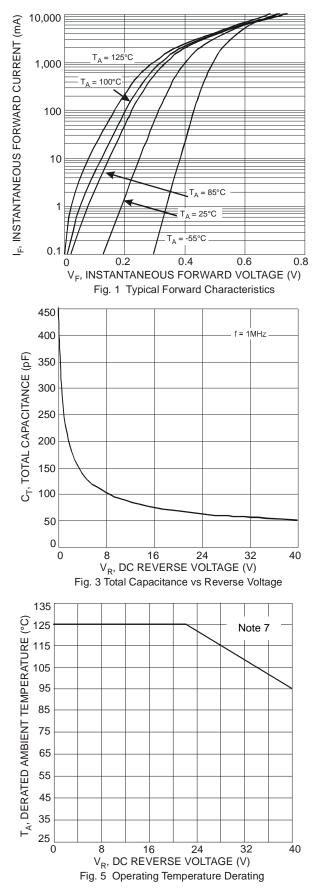
7. Part mounted on FR-4 board with 1.8mm X 2.5mm cathode and 1.8mm X 1.2mm anode, 1 oz. copper pads. T_A = +25°C.

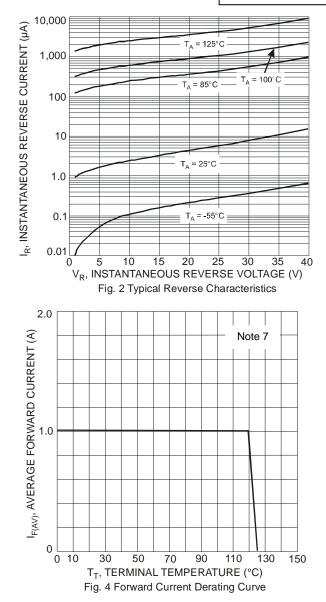
8. Theoretical R_{BJS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.

9. Short duration pulse test to minimize self-heating effect.



DFLS140LQ



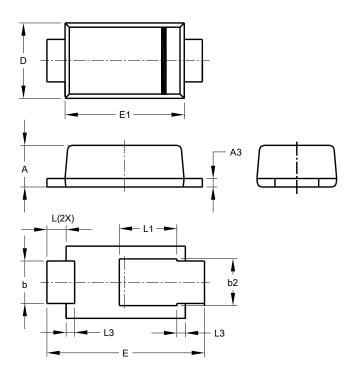


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Package Outline Dimensions

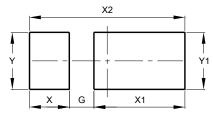
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



1									
	POWERDI [®] 123								
Dim	Min	Max	Тур						
Α	0.93	1.00	0.98						
A3	0.15	0.25	0.20						
b	0.85	1.25	1.00						
b2	1.025	1.125	1.10						
D	1.63	1.93	1.78						
E	3.50	3.90	3.70						
E1	2.60	3.00	2.80						
L	0.40	0.50	0.45						
L1	1.25	1.40	1.35						
L3	0.125	0.275	0.20						
All	Dimensi	ions in r	nm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	0.65
Х	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50



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